


DIM	MIN	MAX
A	0.90	1.45
A1	0.00	0.15
b	0.35	0.50
c	0.08	0.20
D	2.80	3.00
E	2.60	3.00
E1	1.50	1.75
e	0.95 BSC	
e1	1.90 BSC	
L	0.10	0.60

NOTES:

1. ALL DIMENSIONS ARE IN MILLIMETERS.

2. DIMENSIONS  $D$  &  $E1$  INCLUDE MOLD MISMATCH, BUT DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

3. DIMENSION  $L$  IS MEASURED PARALLEL TO THE FLAT SURFACE OF LEAD FOOT.

SIGNATURE		DATE		 <b>Dallas Semiconductor</b>			
DOC. CONTROL:							
ENGR. MGR:							
MFG. ENGR:							
CHECKED BY:							
DRAWN BY:				TITLE MARKETING OUTLINE, SOT-23, 5 LEAD			
		SIZE A	FSCM NO	PART NO.			REV A
DO NOT SCALE DWG.		SCALE N/A		SHEET 1 OF 1			